



(Toll Free no.: 1800 1200 106 Mobile: 8588811998, 9911150880)

Internal Undertaking for Patent/Copyright/Trademark

I/We **HARSH KHATTER (CS)**

Main Applicant: **KIET GROUP OF INSTITUTIONS DELHI - NCR**

Co-applicant / INVENTOR: **HARSH KHATTER (CS) KISHAN AGRAWAL (2226CS1034) RISHIKA AGARWAL (2226CS1084) SHUBHAM SINGH (2226CS1131) YASHASVI SAXENA (2226CS1156)**

I/We have in the course of my study/ employment invented titled, **Enhanced Security and Blockchain based online meeting platform** by using the facilities of Institute and I/We are the true and first inventor.

I/We hereby abide by the IPR Policy which was approved by the management and now public to all stakeholders. Also, the intent of research policy of KIET is towards promoting and encouraging Students/Faculties for recognition of their work by promoting their invention through filing patent/copyright/trademark.

I/We are opting the **OPTION - 1**

I/We would like to engage with the institute for filing the patent/design/copyright/trademark as per IPR policy. I/We do not have any objection by giving unconditional rights to college (KIET Group of Institutions) to file and register the patent/design/copyright/trademark in their name.

I/We hereby state that we shall be abide by the IPR policy clause no. **8.2, 8.3, 9, 9.1, 9.2, 10, 10.1, a, b, c and 10.2** approved by college management.

I/We do not have any objection by giving unconditional rights to college (KIET Group of Institutions) to file and register the patent/design/copyright/trademark in their name. My/Our claims shall be as per the defined ratio in clause no. **10, 10.1, a, b, c and 10.2** of IPR for sharing revenue if generated through commercialization either by transferring technology fee/ royalty/ onetime fee or establishing the venture in future. Both parties shall keep update to each other as per clause and shall abide by the policy.

I/We have given this undertaking at my/our own will and without having any kind of compulsion and pressure by and on behalf of the Institute.

Signature of the Co-Applicant/Inventor(s)

.....

Recommendation of HoD

HOD.....

Signature.....